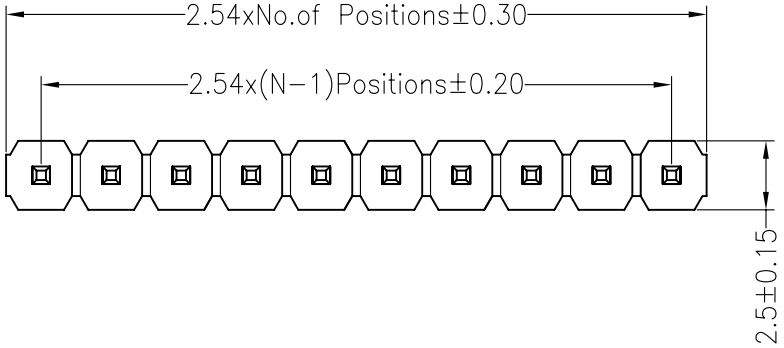
HSF RoHS

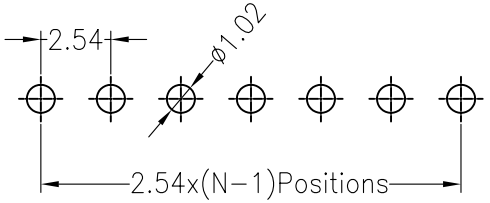
FILE NO :E362810

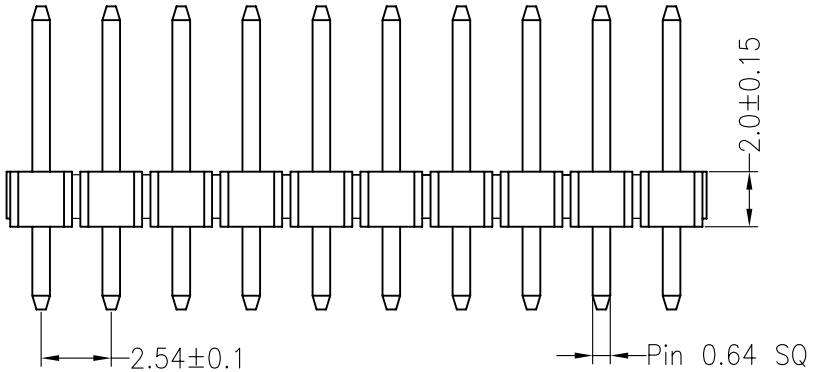
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

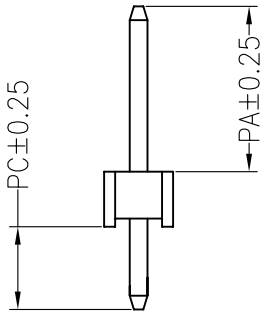
Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1220 11 XX X N XX S XXX X 01

No.of Pins Per Row 1x40 1−−40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Pin Length	Packing 0=PE Bag A=Tray T=Tube

Dimension antitheses list			
ITEM	PA	PC	L
Standard	6.00	3.00	11.0
Alternate			

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.08.24	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.08.24
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	122011XXXNXXSXXXX01
TITLE:	2.54PH H2.0mm 1xNpin 180°